

## **MOSFET**

### 650V CoolMOS™ CFD7A SJ Power Device

650V CoolMOS™ CFD7A is Infineon's latest generation of market leading automotive qualified high voltage CoolMOS™ MOSFETs. In addition to the well-known attributes of high quality and reliability required by the automotive industry, the new CoolMOS™ CFD7A series provides for an integrated fast body diode and can be used for PFC and resonant switching topologies like the ZVS phase-shift full-bridge and LLC.

### **Features**

- $\bullet$  Latest 650V automotive qualified technology with integrated fast body diode on the market featuring ultra low  $Q_{\text{rr}}$
- Lowest FOM R<sub>DS(on)</sub>\*Q<sub>g</sub> and R<sub>DS(on)</sub>\*E<sub>oss</sub>
- 100% avalanche tested
- Best-in-class R<sub>DS(on)</sub> in SMD and THD packages

#### **Benefits**

- · Lower switching losses enabling higher switching frequencies
- · High quality and reliability
- Advanced controllability due to kelvin source
- · Increased efficiency in light load and full load conditions

## Potential applications

Suitable for PFC and DC-DC stages for:

- Unidirectional and bidirectional DC-DC converters,
- · On-Board battery Chargers

## **Product validation**

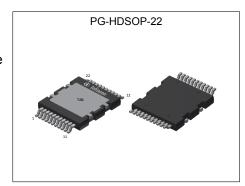
Qualified according to AEC Q101

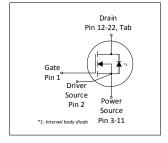
Please note: For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office. The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.



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Parameter	Value	Unit				
V <sub>DS</sub>	650	V				
R <sub>DS(on),max</sub>	29	mΩ				
Q <sub>g,typ</sub>	139	nC				
I <sub>D,pulse</sub>	304	А				
E <sub>oss</sub> @ 400V	20.9	μJ				
Body diode di <sub>F</sub> /dt	1300	A/µs				

Type / Ordering Code	Package	Marking	Related Links
IPDQ65R029CFD7A	PG-HDSOP-22	65A029F7	see Appendix A













# 650V CoolMOS™ CFD7A SJ Power Device IPDQ65R029CFD7A



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1 Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Values			s	l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	85 54	А	T <sub>C</sub> =25°C T <sub>C</sub> =100°C	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	304	Α	T <sub>C</sub> =25°C	
Avalanche energy, single pulse	<b>E</b> <sub>AS</sub>	-	-	358	mJ	I <sub>D</sub> =7.3A; V <sub>DD</sub> =50V; see table 10	
Avalanche current, single pulse	I <sub>AS</sub>	-	-	7.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V <sub>DS</sub> =0400V	
Gate source voltage (static)	V <sub>GS</sub>	-20	-	20	V	static;	
Gate source voltage (dynamic)	V <sub>GS,pulse</sub>	-30	-	30	V	f <sub>repetition</sub> <=100kHz, t <sub>pulse</sub> <= 2ns	
Power dissipation	P <sub>tot</sub>	-	-	463	W	<i>T</i> <sub>C</sub> =25°C	
Storage temperature	T <sub>stg</sub>	-55	-	150	°C	-	
Operating junction temperature	T <sub>j</sub>	-40	-	150	°C	-	
Mounting torque	-	-	-	n.a.	Ncm	-	
Continuous diode forward current	Is	-	-	85	Α	<i>T</i> <sub>C</sub> =25°C	
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	304	Α	T <sub>C</sub> =25°C	
Reverse diode dv/dt <sup>3)</sup>	dv/dt	-	-	70	V/ns	V <sub>DS</sub> =0400V, I <sub>SD</sub> <=35.8A, T <sub>j</sub> =25°0 see table 8	
Maximum diode commutation speed	di <sub>F</sub> /dt	-	-	1300	A/μs	$V_{DS}$ =0400V, $I_{SD}$ <=35.8A, $T_{j}$ =25°0 see table 8	

 $<sup>^{1)}</sup>$  Limited by  $T_{j\;max}.$   $^{2)}$  Pulse width  $t_p$  limited by  $T_{j,max}$   $^{3)}$  Identical low side and high side switch with identical  $R_{\rm G}$ 

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## 2 Thermal characteristics

## **Table 3** Thermal characteristics

Doromotor	Cumbal	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.27	°C/W	-
Soldering temperature, reflow soldering allowed	T <sub>sold</sub>	-	-	260	°C	reflow MSL1

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## 3 Electrical characteristics

at  $T_i$ =25°C, unless otherwise specified

### Table 4 Static characteristics

For applications with applied blocking voltage > 425 V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon.

Danamatan	Combal		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	650	-	-	V	$V_{GS}$ =0V, $I_D$ =1mA	
Gate threshold voltage <sup>1)</sup>	$V_{(GS)th}$	3.5	4	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.79{\rm mA}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	- 160	1 -	μΑ	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>i</sub> =25°C V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C	
Gate-source leakage current	I <sub>GSS</sub>	-	-	0.1	μΑ	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.024 0.053	0.029	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =35.8A, T <sub>j</sub> =25°C V <sub>GS</sub> =10V, I <sub>D</sub> =35.8A, T <sub>j</sub> =150°C	
Gate resistance	R <sub>G</sub>	-	3.8	-	Ω	f=250kHz, open drain	

## **Table 5** Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Bananatan	Values			S	11!4		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	7149	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz	
Output capacitance	Coss	-	106	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz	
Effective output capacitance, energy related <sup>2)</sup>	C <sub>o(er)</sub>	-	261	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V	
Effective output capacitance, time related <sup>3)</sup>	C <sub>o(tr)</sub>	-	2774	-	pF	$I_D$ =constant, $V_{GS}$ =0V, $V_{DS}$ =0400V	
Turn-on delay time	t <sub>d(on)</sub>	-	54	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Rise time	t <sub>r</sub>	-	13	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	159	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Fall time	t <sub>f</sub>	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	

<sup>1)</sup> We do not recommend using the CoolMOS mentioned in this datasheet to operate in "linear mode". For assessment of potential "linear mode", please contact Infineon sales office.

 $<sup>^{2)}</sup>$   $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V  $^{3)}$   $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V

# 650V CoolMOS™ CFD7A SJ Power Device





 Table 6
 Gate charge characteristics

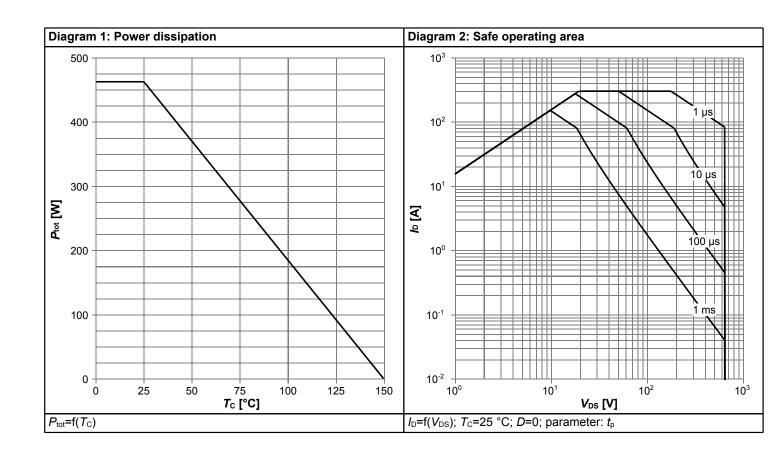
Parameter	Cumbal	Values			Unit	Note / Test Condition	
rarameter	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	41	-	nC	$V_{DD}$ =400V, $I_{D}$ =35.8A, $V_{GS}$ =0 to 10V	
Gate to drain charge	Q <sub>gd</sub>	-	41	-	nC	$V_{DD}$ =400V, $I_{D}$ =35.8A, $V_{GS}$ =0 to 10V	
Gate charge total	Qg	-	139	-	nC	$V_{DD}$ =400V, $I_{D}$ =35.8A, $V_{GS}$ =0 to 10V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.7	-	V	$V_{\rm DD}$ =400V, $I_{\rm D}$ =35.8A, $V_{\rm GS}$ =0 to 10V	

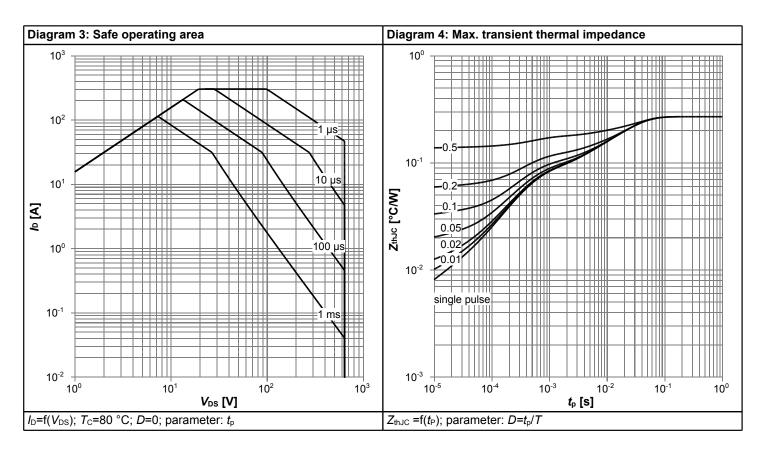
## Table 7 Reverse diode characteristics

Devementar	Complete	Values			11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V <sub>SD</sub>	-	1.0	-	V	V <sub>GS</sub> =0V, I <sub>F</sub> =35.8A, T <sub>j</sub> =25°C
Reverse recovery time	t <sub>rr</sub>	-	208	-	ns	$V_R$ =400V, $I_F$ =35.8A, $d_F/dt$ =100A/ $\mu$ s; see table 8
Reverse recovery charge	Qrr	-	1.60	-	μC	$V_R$ =400V, $I_F$ =35.8A, $di_F/dt$ =100A/ $\mu$ s; see table 8
Peak reverse recovery current	I <sub>rrm</sub>	-	13.1	-	А	$V_R$ =400V, $I_F$ =35.8A, $d_F/dt$ =100A/ $\mu$ s; see table 8

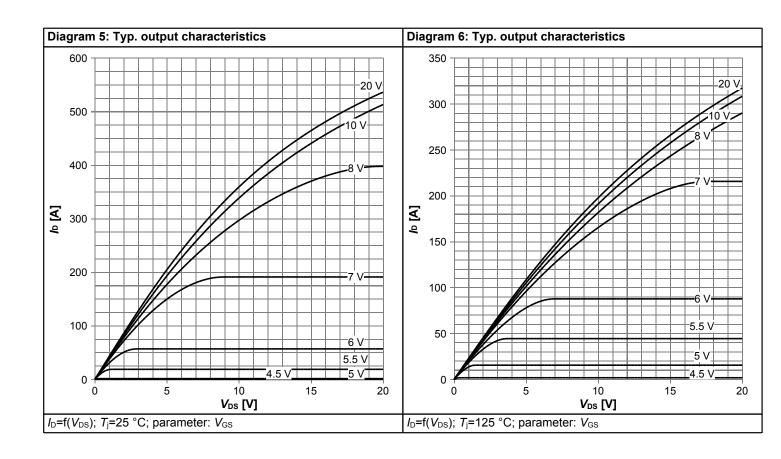


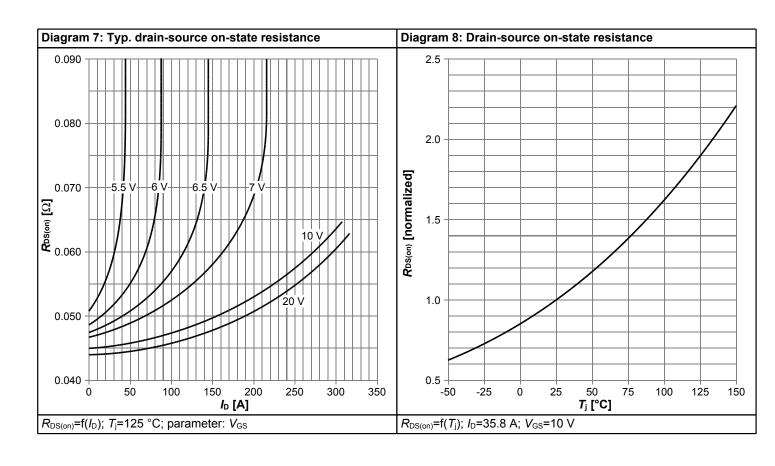
# 4 Electrical characteristics diagrams



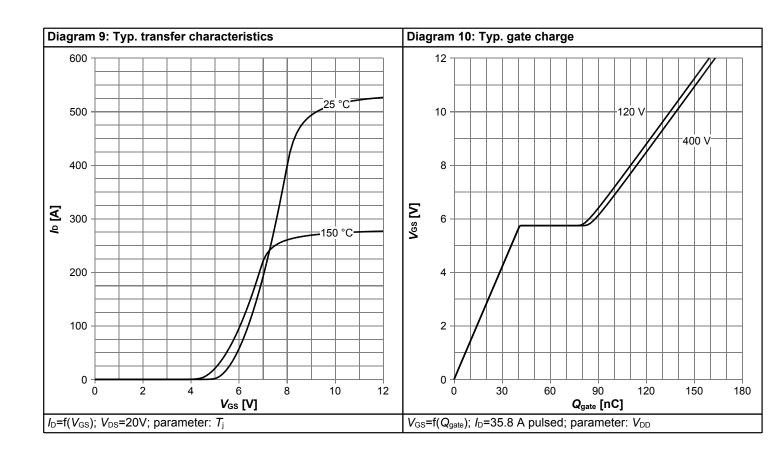


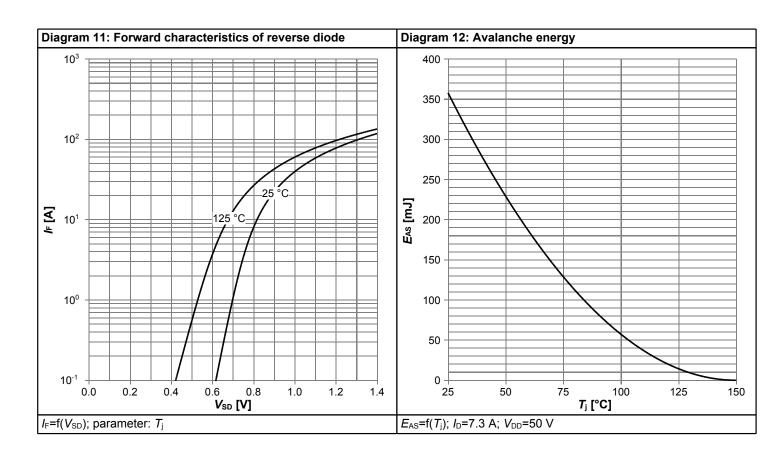




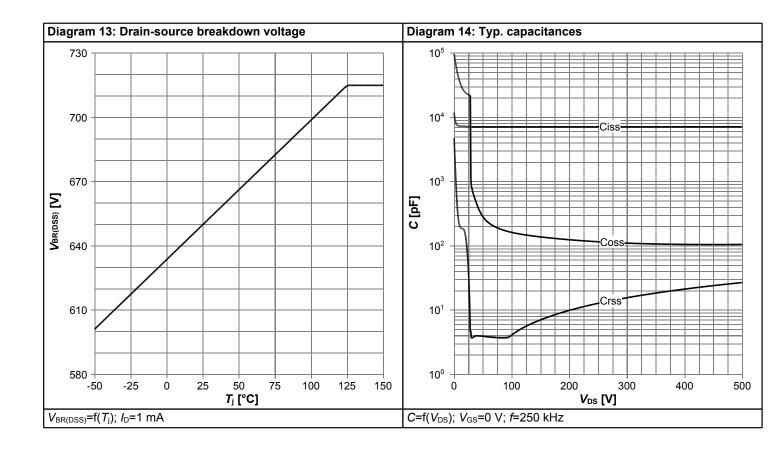


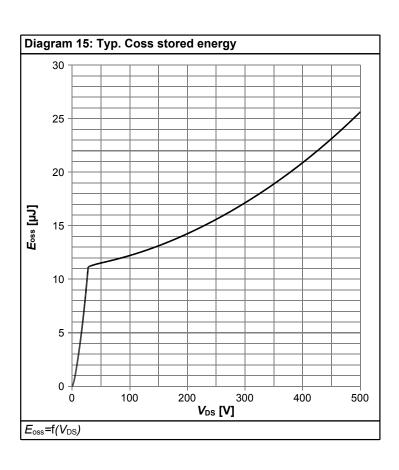














## 5 Test Circuits

**Table 8** Diode characteristics

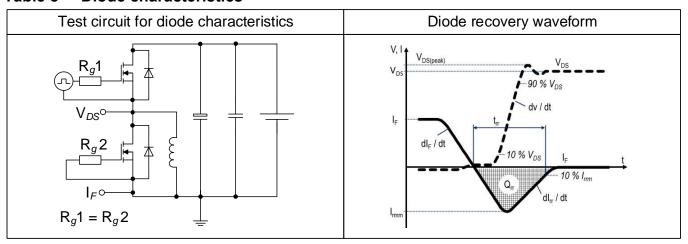


Table 9 Switching times (ss)

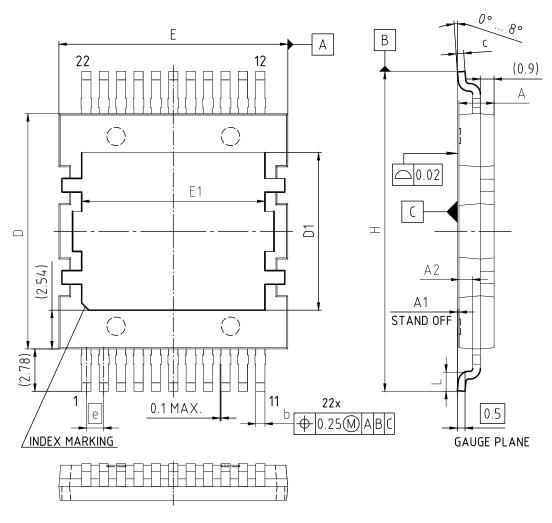


Table 10 Unclamped inductive load (ss)





# 6 Package Outlines



## NOTES:

- 1. ALL DIMENSIONS REFER TO JEDEC STANDARD TO-252 AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
- 2. ALL METAL SUFACES ARE TIN PLATED, EXCEPT AREA OF CUT.

DIMENSIONS	MILLIMETERS					
DIMENSIONS	MIN.	MAX.				
Α	2.20	2.35				
A1	0.00	0.15				
A2	0.89	1.10				
b	0.50	0.70				
С	0.46	0.58				
D	15.30	15.50				
D1	10.23	10.43				
E	14.90	15.10				
E1	11.91	12.11				
е	1.14					
N	22					
Н	20.86 21.06					
L	1.20	1.40				

Figure 1 Outline PG-HDSOP-22, dimensions in mm

# 650V CoolMOS™ CFD7A SJ Power Device IPDQ65R029CFD7A



# 7 Appendix A

## Table 11 Related Links

• IFX CoolMOS CFD7A Webpage: www.infineon.com

• IFX CoolMOS CFD7A application note: www.infineon.com

• IFX CoolMOS CFD7A simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

# 650V CoolMOS™ CFD7A SJ Power Device

#### IPDQ65R029CFD7A



### **Revision History**

IPDQ65R029CFD7A

Revision: 2022-12-14, Rev. 2.1

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Revision	Date Subjects (major changes since last revision)						
2.0	2022-08-30	Release of final version					
2.1	2022-12-14	Updated Benefits section, Thermal characteristics parameter					

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Final Data Sheet 14 Rev. 2.1, 2022-12-14